

12/29/04



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Patent Docket No.: 0071/023001



Commissioner of Patents and Trademarks: Please

102905217

Original document.

1. Name of conveying party(ies):

Kazuyuki HIRAMOTO
Zack PINER
Kyle KONISHI
Takahiro KOBI
Jiancheng LIU
Hiroki NAKAHIRA

Additional name(s) attached? Yes No

2. Name and address of receiving party(ies):

Mori Seiki Co., Ltd.
106 Kitakoriyama-cho,
Yamatokoriyama-shi
Nara-ken
639-1183 Japan

Additional names/addresses attached? Yes No

3. Nature of conveyance:

- Assignment
- Merger
- Security Agreement
- Change of Name
- Other:

Execution Date: December 10, 2004,
December 20, 2004,
December 20, 2004,
December 13, 2004,
December 20, 2004, and
December 10, 2004, respectively

4. Application number(s) or patent number(s): 10/938,869

If this document is being filed with a new application, the execution date of the application is:

A. Patent Application No.(s): 10/938,869 B. Patent No.(s):

Additional numbers attached? Yes No

5. Name/address of party to whom correspondence concerning document should be mailed:

Randolph A. Smith
SMITH PATENT OFFICE
1901 Pennsylvania Ave., N.W.
Suite 200
Washington, D.C. 20006-3433

6. Total number of applications/patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41): \$40

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information

- a) Credit Card Last 4 Numbers: 1006
Expiration Date: July 2007
- b) Please apply any additional charges, or any credits, to our Deposit Account No. 19-2586.

12/30/2004 YPOLITE1 00000122 10938869

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9. Statement and signature: *To the best of my knowledge and belief, the foregoing information is true and correct and the attached is a true copy of the original document.*

Randolph A. Smith
Name of Person Signing

Signature Reg No. 32,548

December 29, 2004
Date

Total number of pages including cover sheet, attachments and document: 3

PATENT

REEL: 016115 FRAME: 0704

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign(s), transfer(s) and set(s) over to:

Mori Seiki Co., Ltd.

having the address:

106 Kitakoriyama-cho, Yamatokoriyama-shi,
Nara-ken, 639-1183 JAPAN

(hereinafter designated as the "ASSIGNEE"), its successors and assigns, the entire right, title, and interest for the United States in the invention; and all applications for patent and any Letters Patent which may be granted therefor, including said application, and all United States Letters Patents which may be granted therefore, and all divisions, reissues, continuations and extensions thereof, the said interest being the entire ownership of said Letters Patent when granted to be held by said ASSIGNEE, its successors, assigns or their legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been and enjoyed by Assignor(s) if this assignment had not been made, the application being known by the Title:

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Attorney Docket No. 0071/023001

for which the undersigned has/have executed an application for patent in the United States of America on the same day herewith. Where this instrument is not filed concurrently with the application, the following identifying information may be added after execution:

Serial No. 10/938,869

Filing Date: 9/13/2004

1. The undersigned hereby agree(s) to sign and execute any further documents and instruments which may be necessary, lawful and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue application or in any amendments, extension of interference proceedings, or otherwise to secure the title thereto to the ASSIGNEE.

2. The undersigned agree(s) to execute all papers and documents and perform any act that may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

3. The undersigned agree(s) to perform all affirmative acts that may be necessary to obtain a grant of a valid United States patent to the ASSIGNEE.

4. The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks in the United States to issue any and all Letters Patents resulting from said application or any division or divisions or continuing applications thereof to the said ASSIGNEE.

5. The undersigned hereby grant(s) to Randolph A. Smith and Smith Patent Office the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Dec. 10, 2004

Date

K. Hiramoto

Typed Name: Kazuyuki HIRAMOTO

Dec. 20, 2004

Date

Z. Pinier

Typed Name: Zack PINER

Dec. 20, 2004

Date

K. Konishi

Typed Name: Kyle KONISHI

Dec. 13, 2004

Date

T. Kobi

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Dec. 20, 2004

Date

J. Liu

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Dec. 10, 2004

Date

H. Nakahira

Typed Name: Hiroki NAKAHIRA